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Design and Heat Transfer Enhancement of Heat Sink by Natural Convection

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ABSTRACT: In this thesis, investigations will be carried out to determine the heat transfer rates in a heat sink by means of varying pitch of the fin with air and helium as the working fluids. Analysis is carried out for heat sink with closed and open enclosure constant wall heat flux and different mass flow rates calculated for Reynolds number 8000, 10000, 12000 and 14000 different pitch 2mm and 4mm. CFD analysis is performed for different cases to determine heat transfer coefficient, pressure drop, mass flow rate and heat transfer rate. Thermal analysis is to determine heat flux and temperature distribution by with different aluminum alloys (aluminum alloy, aluminum alloy 7075). 3D modeling is done in PRO-Engineer. Analysis is performed in ANSYS software.

KEYWORDS: Finite element analysis, heat sink, CFD analysis, thermal analysis.

I. INTRODUCTION

Heat sink: A heat sink transfers thermal energy from a higher temperature device to a lower temperature fluid medium. The fluid medium is frequently air, but can also be water, refrigerants or oil. If the fluid medium is water, the heat sink is frequently called a cold plate. In thermodynamics a heat sink is a heat reservoir that can absorb an arbitrary amount of heat without significantly changing temperature. Practical heat sinks for electronic devices must have a temperature higher than the surroundings to transfer heat by convection, radiation, and conduction. A heat sink is a passive heat exchanger that transfers the heat generated by an electronic or a mechanical device to a fluid medium, often air or a liquid coolant, where it is dissipated away from the device, thereby allowing regulation of the device's temperature at optimal levels.

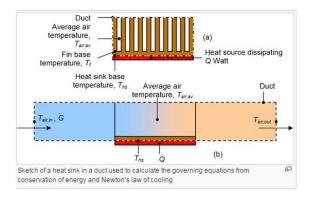


Fig.1. Heat sink

Applications of heat sink:

Microprocessor cooling

Heat dissipation is an unavoidable by-product of electronic devices and circuits. In general, the temperature of the device or component will depend on the thermal resistance from the component to the environment, and the heat dissipated by the component. To ensure that the component temperature does not overheat, a thermal engineer seeks to find an efficient heat transfer path from the device to the environment.



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ADVANTAGES OF HEAT SINK

- dissipate more heat than conventional heat sinks with the same footprint
- reduce heat sink and overall system volume
- increase the aluminum extrusion cooling surface area by two to three times
- Thermoelectric modules
- uninterruptable power supplies
- variable speed motor controls
- · ac welding switches
- power rectification equipment
- laser power supplies
- traction drives

II. LITERATURE REVIEW

A comprehensive theoretical and experimental study was carried out on the thermal performance of a pin fin heat sink. An experimental model was shows that have the capability of predicting influence of effective surface area of pin fin on thermal heat transfer coefficient. Pin fin array are used in many applications to enhance heat transfer and also shows enhancement of heat transfer coefficient for different material of fin. Several different type of experiment test were run out with corresponding variation including the material of pin fin and different perforation on pin fin .Perforation with circular cross section are along the height of pin fin and there number varies from 1 to 3. The result indicates that the material having higher thermal conductivity with higher number of perforation gives more heat transfer coefficient. The effect of perforation on heat transfer was investigated.

III. PROBLEM DESCRIPTION

Investigations will be carried out to determine the heat transfer rates in a heat sink by means of varying pitch of the fin with air and helium as the working fluids. Analysis is carried out for heat sink with closed and open enclosure constant wall heat flux and different mass flow rates calculated for Reynolds number 8000, 10000, 12000 and 14000 different pitch 2mm and 4mm. temperature distribution by with different aluminum alloys (aluminum alloy, aluminum alloy 7075).

IV. INTRODUCTION TO CAD/CAE

Computer-aided design (CAD), also known as computer-aided design and drafting (CADD), is the use of computer technology for the process of design and design-documentation.

INTRODUCTION TO PRO-ENGINEER

Pro/ENGINEER Wildfire is the standard in 3D product design, featuring industry-leading productivity tools that promote best practices in design while ensuring compliance with your industry and company standards. Integrated Pro/ENGINEER CAD/CAM/CAE solutions allow you to design faster than ever, while maximizing innovation and quality to ultimately create exceptional products.

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Different modules in pro/engineer

Part design, Assembly, Drawing& Sheet metal.

INTRODUCTION TO FINITE ELEMENT METHOD:

Finite Element Method (FEM) is also called as Finite Element Analysis (FEA). Finite Element Method is a basic analysis technique for resolving and substituting complicated problems by simpler ones, obtaining approximate solutions Finite element method being a flexible tool is used in various industries to solve several practical engineering problems. In finite element method it is feasible to generate the relative results.

V. RESULTS AND DISCUSSIONS

Models of heat sink using pro-e wildfire 5.0:

PRO-E 3D MODELS

HEAT SINK 3D MODELS

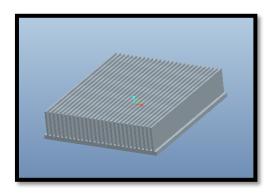


Fig: 2pitch2; height 24

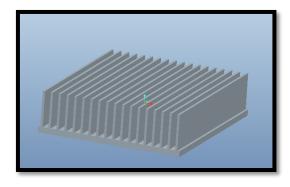


Fig: 3 pitch4; height 24



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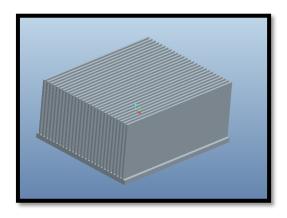


Fig: 4 pitch2; height48

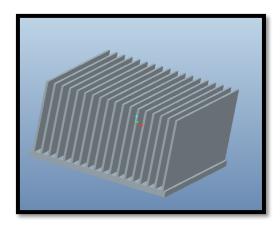


Fig: 5 pitch4; height 48

2D DRAWINGS OF HEAT SINK

PITCH2; HEIGHT 24

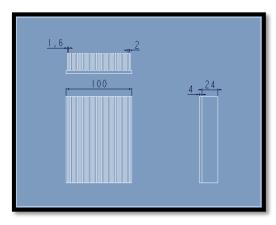


Fig: 6 pitch2; height 24



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PITCH2; HEIGHT 24

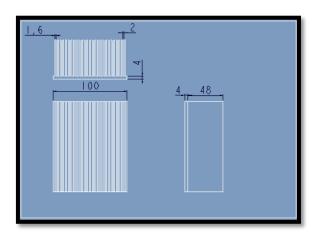


Fig:7 pitch4; height 24

V.VELOCITY CALCULATIONS

FOR REYNOLDS NUMBER 8000 - 14000

Reynolds number - 8000

 $Re = \rho v L/\mu$

 ρ =densitykg/s

V=velocity m/s

L=length of the tube (mm)

μ=viscosity kg/ms

$$Re = \frac{\rho \times V \times L}{u}$$

Fin Height = 24

$$8000 = \frac{1.225 \times V \times 24}{1.7894e - 05}$$

V=4.86911 m/s

Fin Height = 48

$$8000 = \frac{1.225 \times V \times 48}{1.7894e - 05}$$

V=2.43455/s

$Reynolds\ number-10000$

Fin Height = 24

$$10000 = \frac{1.225 \times V \times 24}{1.7894e - 05}$$

V = 6.08639 m/s

Fin Height = 48

$$10000 = \frac{1.225 \times V \times 48}{1.7894e - 05}$$

V=3.04319m/s



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Reynolds number - 12000

Fin Height = 24

$$12000 = \frac{1.225 \times V \times 24}{1.7894e - 05}$$

V=7.30367m/s

Fin Height = 48

$$12000 = \frac{1.225 \times V \times 48}{1.7894e - 05}$$

V=3.04319m/s

Reynolds number - 14000

Fin Height
$$= 24$$

$$14000 = \frac{1.225 \times V \times 24}{1.7894e - 05}$$

V=8.52095 m/s

$$14000 = \frac{1.225 \times V \times 48}{1.7894e - 05}$$

V=4.26047m/s

CFD ANALYSIS OF HEAT SINK WITH CLOSED ENCLOSURE FLUID -AIR

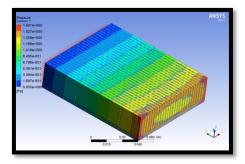


Fig: 8 Pressure

According to the above contour plot, the maximum static pressure one end of the fins because the applying the boundary conditions at inlet of the closed enclosure one end surface and minimum static pressure at the other end of the fins. According to the above contour plot, the maximum pressure is 1.697e+00Pa and minimum static pressure is 1.697e-001e+01Pa

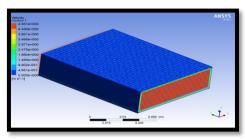


Fig: 9 velocity



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According to the above contour plot, the maximum velocity magnitude inside between fins at one end of the tubes because the applying the boundary conditions at inlet of the closed enclosure one end surface and minimum velocity magnitude at the outer surface of the fins. According to the above contour plot, the maximum velocity is 4.951e+000 and minimum velocity magnitude is 4.951e-001

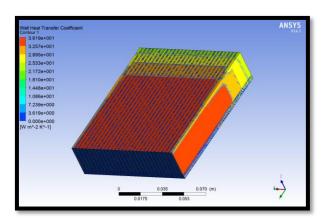
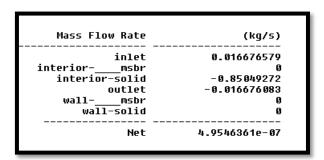


Fig: 10 Heat transfer coefficient

According to the above contour plot, the maximum heat transfer coefficient of the heat sink at half of the heat sink from one end and minimum heat transfer coefficient another end of the heat sink. According to the above contour plot, the maximum heat transfer coefficient is 3.619e+001w/m²-k and minimum heat transfer coefficient is 3.619e+001w/m²-k.

MASS FLOW RATE



HEAT TRANSFER RATE

Total Heat Transfer Rate	(w)
inlet outlet wall- <u></u> msbr wall-solid	1256.3077 -1195.5676 0 -61.252232
Net	-0.51211929



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5.4. THERMAL ANALYSIS OF HEAT SINK

MATERIALS- ALUMINUM ALLOY &ALUMINUM ALLOY 7075

PITCH2; HEIGHT 24

MATERIAL- ALUMINUM ALLOY

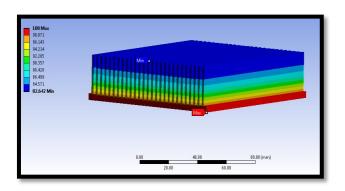


Fig 11 Temperature

According to the contour plot, the temperature distribution maximum temperature at base plate of the heat sink. We applied the temperature bottom surface of the heat sink base plate and applied convection to fins. Then the maximum temperature at bottom surface of the heat sink base plate and minimum temperature at end of the fins.

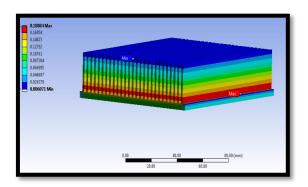


Fig: 12 heat flux

According to the contour plot, the maximum heat flux at starting portion of the heat sink fins. We applied the temperature bottom surface of the heat sink base plate and applied convection to fins. Then the maximum heat flux at starting portion of the heat sink fins and minimum heat flux at end of the fins.

According to the above contour plot, the maximum heat flux is 0.18884 w/mm² and minimum heat flux is 0.006071w/mm².

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VI. RESULTS AND DISCUSSIONS

THERMAL ANALYSIS RESULT TABLE

models	materials	Temperature(0C)		Heat	
		Max.	Min.	flux(w/mm²)	
Pitch 2;height 24	Aluminum alloy	100	82.642	0.18884	
	Aluminum alloy 7075	100	83.469	0.19042	
Pitch 4;height 24	Aluminum alloy	100	82.979	0.18102	
	Aluminum alloy 7075	100	83.79	0.18963	
Pitch 2;height 48	Aluminum alloy	100	57.698	0.27751	
_	Aluminum alloy 7075	100	59.463	0.28446	
Pitch 4;height 48	Aluminum alloy	100	57.996	0.27863	
	Aluminum alloy 7075	100	59.755	0.28555	

CFD ANALYSIS RESULT TABLE

models	Reynolds	Pressure	Velocity	Heat	Mass flow	Heat transfer
	numbers	(Pa)	(m/s)	transfer	rate(kg/s)	rate(w)
				coefficient		
				(w/mm2-k)		
Pitch	8000	1.697e+000	4.951e+000	3.619e+001	4.9546e-07	0.51211929
2;height 24	10000	2.566e+000	6.195e+000	4.323e+001	4.7869e-07	0.55114746
	12000	3.568e+000	7.431e+000	4.977e+001	5.79282e- 07	0.57193756
	14000	4.678e+000	8.667e+000	5.600e+001	4.56348e- 07	0.61563873
Pitch	8000	1.703e+000	4.958e+000	3.624e+001	6.3888e-07	0.045654
4;height 24	10000	2.569e+000	6.192e+000	4.323e+001	4.00468e- 07	0.023071289
	12000	3.557e+000	7.431e+000	4.900e+001	4.88013e- 07	0.0388183
	14000	4.677e+000	8.666e+000	5.600e+001	4.52622e- 07	0.0292968
Pitch 2;height	8000	3.956e-001	2.470e+000	3.025e+001	2.30968e- 07	0.010864258
48	10000	5.339e-001	3.082e+000	3.025e+001	2.209097e- 06	0.18188477
	12000	7.536e-001	3.697e+000	3.025e+001	5.7742e-08	0.0023193359
	14000	9.532e-001	4.313e+000	3.232e+001	2.421438e- 07	0.028442383
Pitch	8000	4.117e-001	2.47e+000	2.048e+001	9.8995e-07	0.067993164
4;height 48	10000	5.311e-001	3.083e+000	2.422e+001	1.27218e- 06	0.079589844
	12000	7.321e-001	3.697e+000	2.839e+001	2.22399e- 06	0.15661621
	14000	9.531e-001	4.313e+000	3.232e+00	1.508742e- 07	0.023071284



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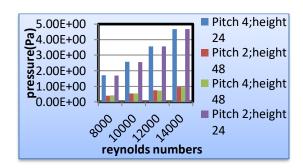
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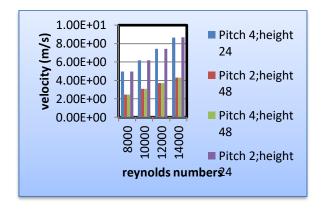
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GRAPHS

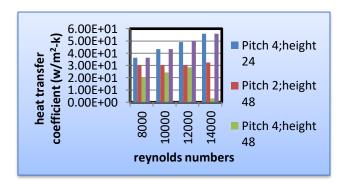
Pressure plot



Velocity plot



Heat transfer coefficient plot





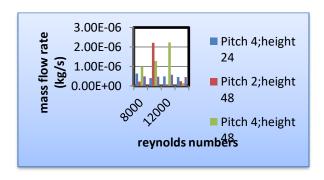
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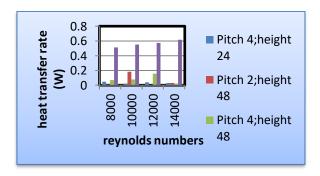
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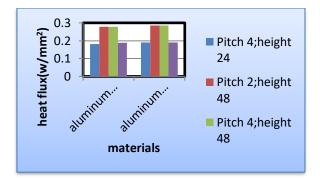
Mass flow rate plot



Heat transfer rate plot



Thermal flux plot



VII. CONCLUSION

Thermal analysis is to determine heat flux and temperature distribution by with different aluminum alloys (\aluminum alloy, 7075). By observing the CFD Analysis the heat transfer rate and mass flow rate are increases by increasing the Reynolds number and more heat transfer rate for pitch2 mm and height 24mm heat sink. By observing the thermal analysis the heat flux value more for aluminum alloy 7075 material. So we conclude the aluminum alloy 7075 material is better for heat sink.



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